

## HEADERS & RECEPTACLES





✓ Active



## TE CONNECTIVITY (TE) 08 MTE HDR SRRA LATCH W/HLDWN AMP | AMPMODU MTE

5-104361-7 TE Internal Number: 5-104361-7

## Always EU RoHS/ELV Compliant

Centerline 2.54 mm [.1 in ]
Number of Positions 8
PCB Mounting Orientation Right Angle
PCB Mounting Style Through Hole (SMT Compatible)
Number of Rows 1

Product Drawings	HEADER ASSY, AMPMODU MTE, RIGHT ANGLE, SINGLE ROW, .100 POSTS, WITH LATCH & HOLD DOWNS PDF English
CAD Files	3D PDF PDF English
	Customer View Model 2D_DXF.ZIP English
	Customer View Model 3D_IGS.ZIP English
	Customer View Model 3D_STP.ZIP English
Catalog Pages/Data Sheets	AMPMODU_INTERCONNECTION_SYSTEM_SECTION5_CONT PDF English
	AMPMODU MTE INTERCONNECT SYSTEM PDF English
Product Specifications	
Application Specification	AMPMODU MTE Interconnection System PDF English

Please review product documents or **contact us** for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.

Product Type Features	PCB Mounting Orientation	Right Angle
	Product Type	Connector
	Connector Type	Header
	Strain Relief	Without
	Row-to-Row Spacing	2.54 mm [ .1 in ]
	Connector Style	Plug
	PCB Orientation Feature	No
	Applies To	Printed Circuit Board
Configuration Features	Number of Positions	8
	Number of Rows	1
	Backwall/Post Interruptions	Without
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Electrical Characteristics	Dielectric Withstanding Voltage	600 V
	Insulation Resistance	5000 ΜΩ
	Termination Resistance	15 ΜΩ
Body Features	Header Type	Shrouded
Contact Features		
Contact Features	Contact Mating Area Plating Material	Gold
Contact realures	Contact Mating Area Plating Material Contact Mating Area Plating Thickness (µin)	Gold 15
Contact realures		
Contact realures	Contact Mating Area Plating Thickness (µin)	15
Contact realures	Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness	15 2.54 – 5.08 μm [ 100 – 200 μin ]
	Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape	15 2.54 – 5.08 μm [ 100 – 200 μin ] Square
	Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Contact Termination Area Plating Material	15 2.54 – 5.08 μm [ 100 – 200 μin ] Square Tin
	Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Contact Termination Area Plating Material Tail Plating Material	15 2.54 – 5.08 μm [ 100 – 200 μin ] Square Tin Tin
	Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Contact Termination Area Plating Material Tail Plating Material Tail Plating Thickness	15 2.54 – 5.08 μm [ 100 – 200 μin ] Square Tin Tin 2.54 – 5.08 μm [ 100 – 200 μin ]
	Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Contact Termination Area Plating Material Tail Plating Material Tail Plating Thickness Contact Type	15 2.54 – 5.08 μm [ 100 – 200 μin ] Square Tin 2.54 – 5.08 μm [ 100 – 200 μin ] Pin
	Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Contact Termination Area Plating Material Tail Plating Material Tail Plating Thickness Contact Type Solder Tail Contact Plating Material	15 2.54 – 5.08 μm [ 100 – 200 μin ] Square Tin 2.54 – 5.08 μm [ 100 – 200 μin ] Pin Tin
	Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Contact Termination Area Plating Material Tail Plating Material Tail Plating Thickness Contact Type Solder Tail Contact Plating Material Contact Current Rating (A)	15 2.54 – 5.08 μm [ 100 – 200 μin ] Square Tin 2.54 – 5.08 μm [ 100 – 200 μin ] Pin Tin
Termination Features	Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Contact Termination Area Plating Material Tail Plating Material Tail Plating Thickness Contact Type Solder Tail Contact Plating Material Contact Current Rating (A) Contact Termination Area Plating Material Finish	15 2.54 – 5.08 μm [ 100 – 200 μin ] Square Tin 2.54 – 5.08 μm [ 100 – 200 μin ] Pin 3 Matte
	Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Contact Termination Area Plating Material Tail Plating Material Tail Plating Thickness Contact Type Solder Tail Contact Plating Material Contact Current Rating (A) Contact Termination Area Plating Material Finish Contact Base Material	15 2.54 – 5.08 μm [ 100 – 200 μin ] Square Tin 2.54 – 5.08 μm [ 100 – 200 μin ] Pin Tin 3 Matte Brass
Termination Features	Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Contact Termination Area Plating Material Tail Plating Material Tail Plating Thickness Contact Type Solder Tail Contact Plating Material Contact Current Rating (A) Contact Termination Area Plating Material Finish Contact Base Material	15 2.54 – 5.08 μm [ 100 – 200 μin ] Square Tin 2.54 – 5.08 μm [ 100 – 200 μin ] Pin Tin 3 Matte Brass Crimp, Insulation Displacement Crimp (IDC)

	PCB Mount Retention	With
	PCB Mount Retention Type	Hold-Down
	Contact Retention	With
	Mating Alignment Type	Latched
	Contact Retention Type	Locking Lance
	Mating Retention Type	Hold-Down
	Mating Alignment	With
Housing Features	Centerline	2.54 mm [ .1 in ]
	Housing Color	Black
	Housing Material	Thermoplastic
Dimensions	Tail Length	3.3 mm [ .13 in ]
	Mating Post Length	5.84 mm [ .23 in ]
	PCB Thickness (Recommended)	1.57 mm [ .062 in ]
	Height	13.59 mm [ .535 in ]
	Length	22.86 mm [ .9 in ]
Usage Conditions	Temperature Rating	High
	Operating Temperature Range (°C)	-65 – 105
Operation/Application	For Use With	Receptacle Housing Assembly
	Pick and Place Cover	Without
Industry Standards	UL Flammability Rating	UL 94V-0
	Approved Standards	CSA LR7189, UL E28476
Packaging Features	Packaging Method	Tube, Tube/Box
	Packaging Quantity	23
Other	Comment	Use Keying Tool No. 91417-1 to remove post for keying.

Product Compliance

Statement of Compliance PDF

VIEW ALL PRODUCT COMPLIANCE